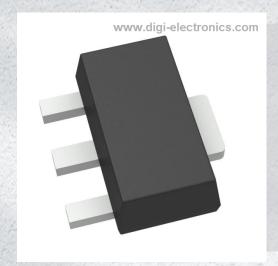


# **DPLS350Y-13 Datasheet**



https://www.DiGi-Electronics.com

DiGi Electronics Part Number DPLS350Y-13-DG

Manufacturer Diodes Incorporated

Manufacturer Product Number DPLS350Y-13

Description TRANS PNP 50V 3A SOT89-3

Detailed Description Bipolar (BJT) Transistor PNP 50 V 3 A 100MHz 1 W S

urface Mount SOT-89-3



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



# **Purchase and inquiry**

Manufacturer Product Number:	Manufacturer:
DPLS350Y-13	Diodes Incorporated
Series:	Product Status:
	Active
Transistor Type:	Current - Collector (Ic) (Max):
PNP	3 A
Voltage - Collector Emitter Breakdown (Max):	Vce Saturation (Max) @ lb, Ic:
50 V	390mV @ 300mA, 3A
Current - Collector Cutoff (Max):	DC Current Gain (hFE) (Min) @ Ic, Vce:
100nA	200 @ 1A, 2V
Power - Max:	Frequency - Transition:
1 W	100MHz
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Package / Case:	Supplier Device Package:
TO-243AA	SOT-89-3
Base Product Number:	
DPLS350	

# **Environmental & Export classification**

8541.29.0075

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	





#### **50V PNP LOW SATURATION POWER TRANSISTOR IN SOT89**

#### **Features**

- BV<sub>CEO</sub> > -50V
- I<sub>C</sub> = -3A High Continuous Collector Current
- I<sub>CM</sub> up to -5A Peak Pulse Current
- 2W Power Dissipation
- Low Saturation Voltage V<sub>CE(sat)</sub> < -180mV @ 1A</li>
- $R_{CE(sat)} = 67m\Omega$  @ 2A for a Low Equivalent On-Resistance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

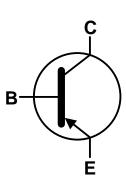
#### **Mechanical Data**

- Case: SOT89
- Case Material: Molded Plastic, "Green" Molding Compound UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.052 grams (Approximate)

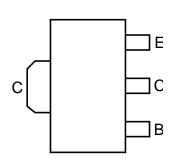
#### **SOT89**







Device Symbol



Top View Pin-Out

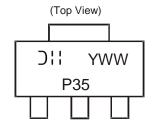
### **Ordering Information** (Note 4)

Part Number	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DPLS350Y-13	P35	13	12	2,500
DPLS350Y-13R	P35	13	12	4,000
DPLS350YTC	P35	13	12	4,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
- 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**



P35 = Product Type Marking Code: YWW = Date Code Marking Y = Last Digit of Year ex: 5 = 2015 WW = Week Code 01 - 53



### **Absolute Maximum Ratings** ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-50	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-50	V
Emitter-Base Voltage	V <sub>EBO</sub>	-6	V
Continuous Collector Current	Ic	-3	Α
Peak Pulse Current	I <sub>CM</sub>	-5	Α
Base Current	I <sub>B</sub>	-500	mA

### **Thermal Characteristics**

Characteristic		Symbol	Value	Unit	
	(Note 5)		1		
Power Dissipation	(Note 6)	$P_{D}$	1.6	W	
	(Note 7)		2.0		
	(Note 5)		125		
Thermal Resistance, Junction to Ambient Air	(Note 6)	$R_{ hetaJA}$	78	°C/W	
	(Note 7)		62.5		
Thermal Resistance, Junction to Lead	(Note 8)	$R_{ heta JL}$	5.7	°C/W	
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C	

### ESD Ratings (Note 9)

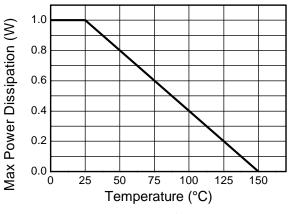
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

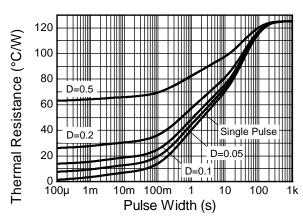
Notes:

- 5. For a device mounted with the exposed collector pad on 15mm x 15mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.
- 6. Same as note (5), except the device is mounted on 25mm x 25mm 1oz copper.
- 7. Same as note (5), except the device is mounted on 50mm x 50mm 1oz copper.
- 8. Thermal resistance from junction to solder-point (on the exposed collector pad).
- Refer to JEDEC specification JESD22-A114 and JESD22-A115.



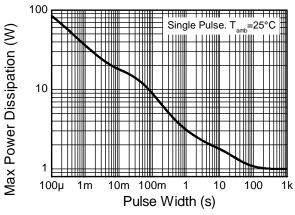
### **Thermal Characteristics and Derating Information**



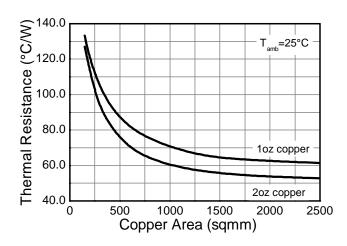


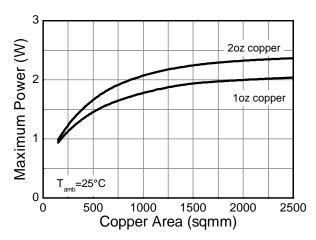
**Derating Curve** 

**Transient Thermal Impedance** 



**Pulse Power Dissipation** 





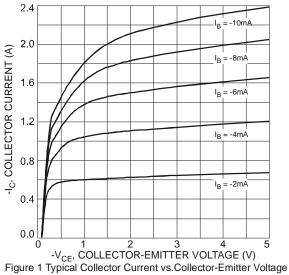


# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	-50	_	_	V	I <sub>C</sub> = -100μA
Collector-Emitter Breakdown Voltage (Note 10)	BV <sub>CEO</sub>	-50	_	_	V	I <sub>C</sub> = -10mA
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	-6	_	_	V	I <sub>E</sub> = -100μA
Collector-Emitter Cut-off Current	I <sub>CES</sub>	_	_	-100	nA	V <sub>CE</sub> = -50V
Collector Cut-off Current		_	_	-100	nA	V <sub>CB</sub> = -50V
Collector Cut-off Current	I <sub>CBO</sub>			-50	μΑ	V <sub>CB</sub> = -50V, T <sub>A</sub> = +150°C
Emitter Cut-off Current	I <sub>EBO</sub>	_	_	-100	nA	V <sub>EB</sub> = -5V
		200		_		I <sub>C</sub> = -100mA, V <sub>CE</sub> = -2V
		200		_		I <sub>C</sub> = -500mA, V <sub>CE</sub> = -2V
Static Forward Current Transfer Ratio (Note 10)	h <sub>FE</sub>	200	_	450	_	I <sub>C</sub> = -1A, V <sub>CE</sub> = -2V
		130		_		I <sub>C</sub> = -2A, V <sub>CE</sub> = -2V
		80		_		I <sub>C</sub> = -3A, V <sub>CE</sub> = -2V
				-90		I <sub>C</sub> = -500mA, I <sub>B</sub> = -50mA
	V <sub>CE(sat)</sub>	_	_	-180	mV	$I_C = -1A$ , $I_B = -50mA$
Collector-Emitter Saturation Voltage (Note 10)				-320		I <sub>C</sub> = -2A, I <sub>B</sub> = -100mA
				-270		I <sub>C</sub> = -2A, I <sub>B</sub> = -200mA
				-390		I <sub>C</sub> = -3A, I <sub>B</sub> = -300mA
Equivalent On-Resistance	R <sub>CE(sat)</sub>	_	67	135	mΩ	I <sub>C</sub> = -2A, I <sub>B</sub> = -200mA
Base-Emitter Saturation Voltage (Note 10)		_	_	-1.1	V	$I_C = -2A$ , $I_B = -100mA$
Base-Emilier Saturation voltage (Note 10)	V <sub>BE(sat)</sub>			-1.2		$I_C = -3A$ , $I_B = -300mA$
Base-Emitter Turn-On Current (Note 10)	V <sub>BE(on)</sub>	1	_	-1.1	V	$I_{C} = -1A, V_{CE} = -2V$
Transition Frequency	f⊤	100	_	-	MHz	$I_C = -100 \text{mA}, V_{CE} = -5 \text{V},$ f = 100 MHz
Collector Output Capacitance	C <sub>obo</sub>	_	_	35	pF	V <sub>CB</sub> = -10V, I <sub>E</sub> = 0, f = 1MHz
Turn-On Time	t <sub>(ON)</sub>	_	87	_	ns	
Delay Time	t <sub>D</sub>	_	41	_	ns	
Rise Time	t <sub>R</sub>	_	46	_	ns	$V_{CC} = -30v$ ,
Turn-Off Time	t <sub>(OFF)</sub>	_	294	_	ns	$I_{CC} = 150 \text{mA}$ $I_{B1} = -I_{B2} = 15 \text{mA}$
Storage Time	t <sub>S</sub>	_	250	_	ns	J.RJ - J.RZ - 12111V
Fall Time	t <sub>F</sub>	_	44	_	ns	

Note: 10. Measured under pulsed conditions. Pulse width  $\leq$  300 $\mu$ s. Duty cycle  $\leq$  2%.





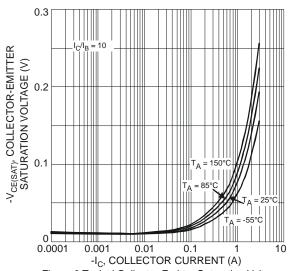


Figure 3 Typical Collector-Emitter Saturation Voltage vs. Collector Current

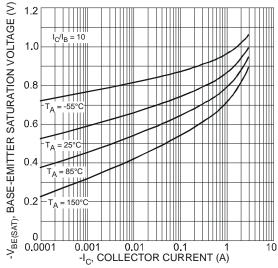


Figure 5 Typical Base-Emitter Saturation Voltage vs. Collector Current

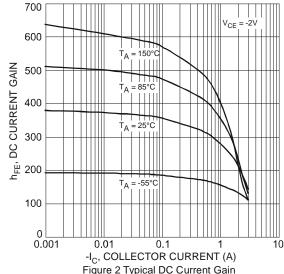
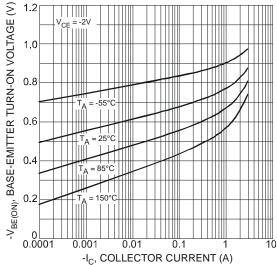


Figure 2 Typical DC Current Gain vs. Collector Current



-I<sub>C</sub>, COLLECTOR CURRENT (A) Figure 4 Typical Base-Emitter Turn-On Voltage vs. Collector Current

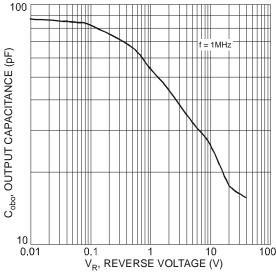
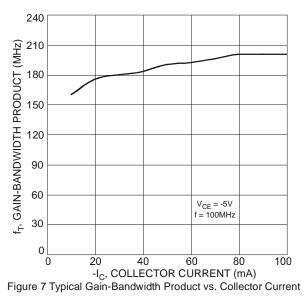


Figure 6 Typical Output Capacitance Characteristics



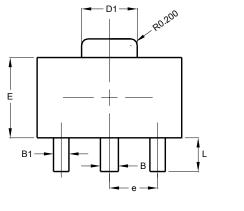


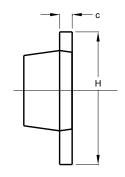


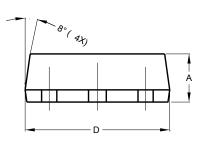
### **Package Outline Dimensions**

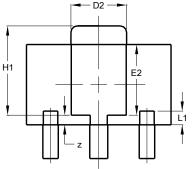
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

#### SOT89







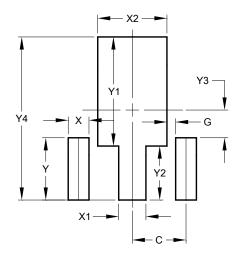


SOT89					
Dim	Min	Max	Тур		
Α	1.40	1.60	1.50		
В	0.50	0.62	0.56		
B1	0.42	0.54	0.48		
С	0.35	0.43	0.38		
D	4.40	4.60	4.50		
D1	1.62	1.83	1.733		
D2	1.61	1.81	1.71		
Е	2.40	2.60	2.50		
E2	2.05	2.35	2.20		
е	-	-	1.50		
Н	3.95	4.25	4.10		
H1	2.63	2.93	2.78		
L	0.90	1.20	1.05		
L1	0.327	0.527	0.427		
Z	0.20	0.40	0.30		
All Dimensions in mm					

### **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

#### SOT89



Dimensions	Value (in mm)		
С	1.500		
G	0.244		
Х	0.580		
X1	0.760		
X2	1.933		
Υ	1.730		
Y1	3.030		
Y2	1.500		
Y3	0.770		
Y4	4.530		



#### **IMPORTANT NOTICE**

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

#### LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
  - 1. are intended to implant into the body, or
  - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2015, Diodes Incorporated

www.diodes.com



### **OUR CERTIFICATE**

DiGi provide top-quality products and perfect service for customer worldwide through standardization, technological innovation and continuous improvement. DiGi through third-party certification, we striciy control the quality of products and services. Welcome your RFQ to Email: Info@DiGi-Electronics.com

















Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com